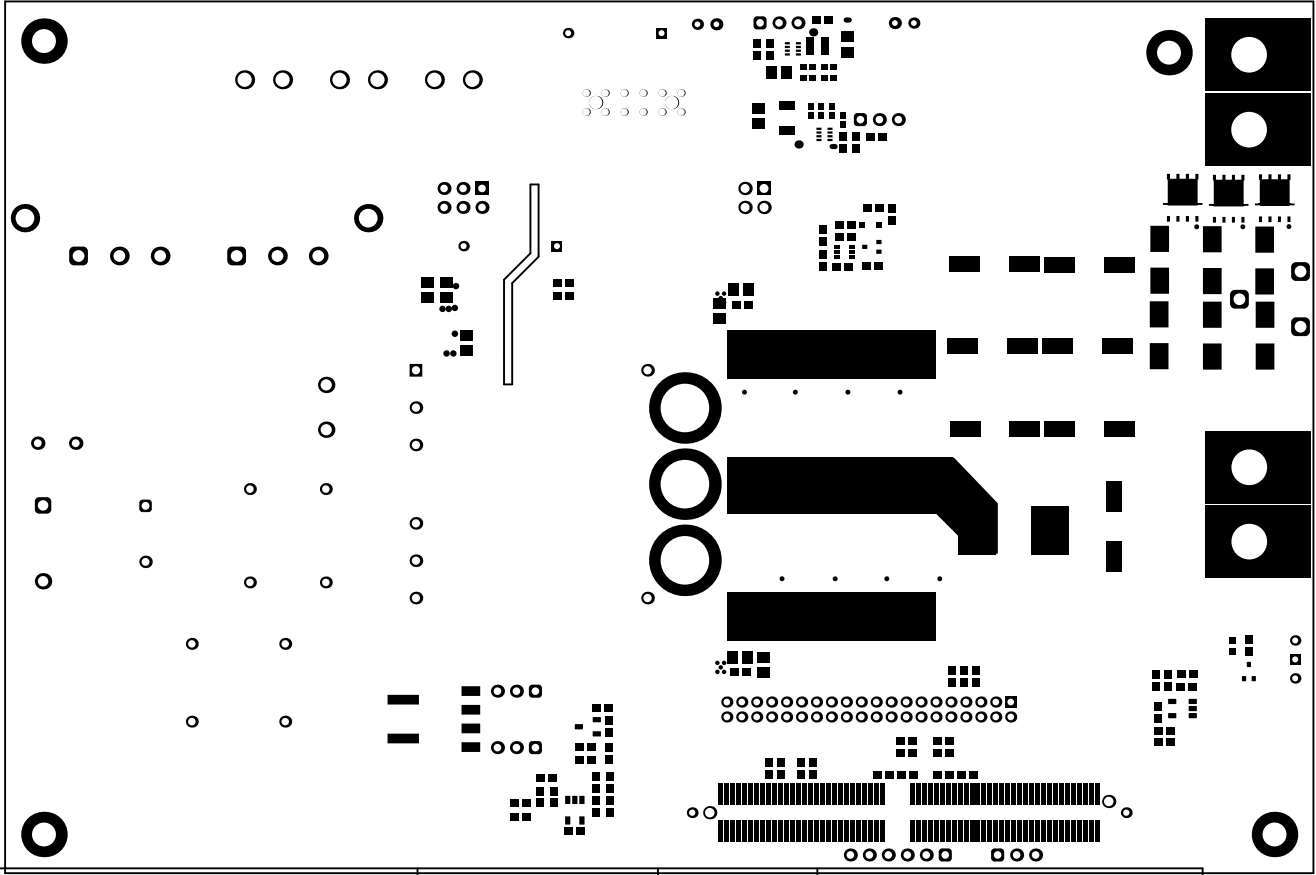
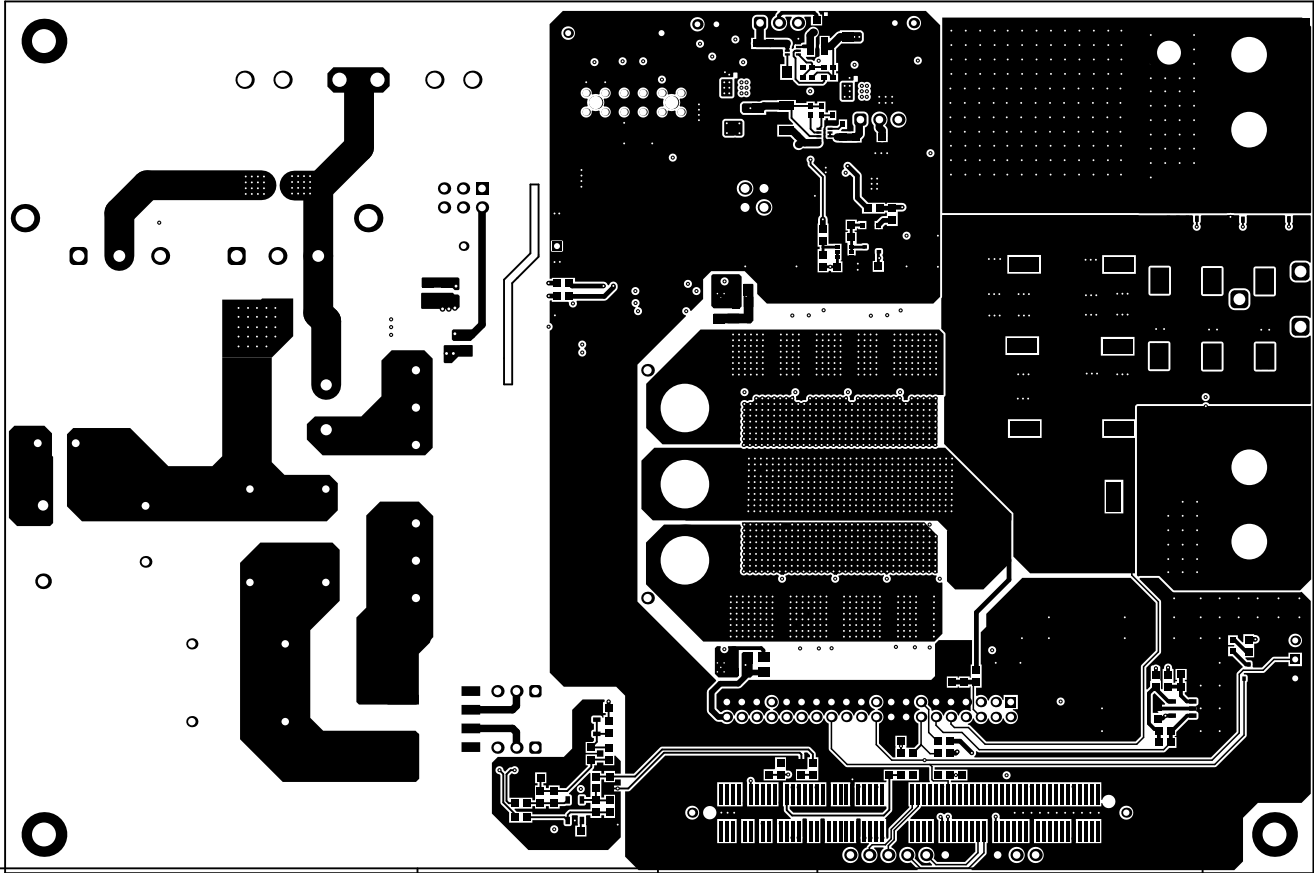


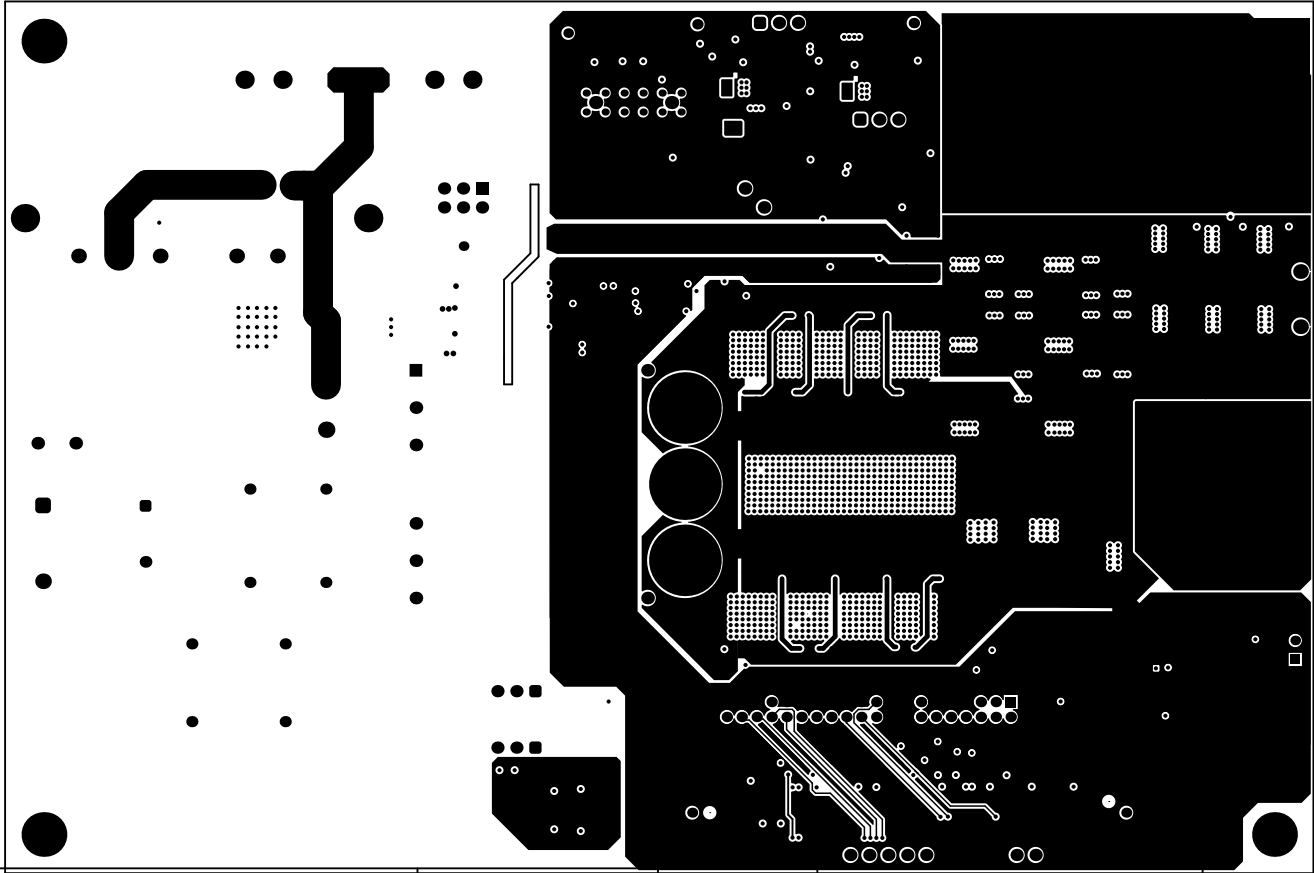
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: .TID		
PLOT NAME = Top Overlay	GENERATED : 9/19/2023 1:29:20 PM	TEXAS INSTRUMENTS	



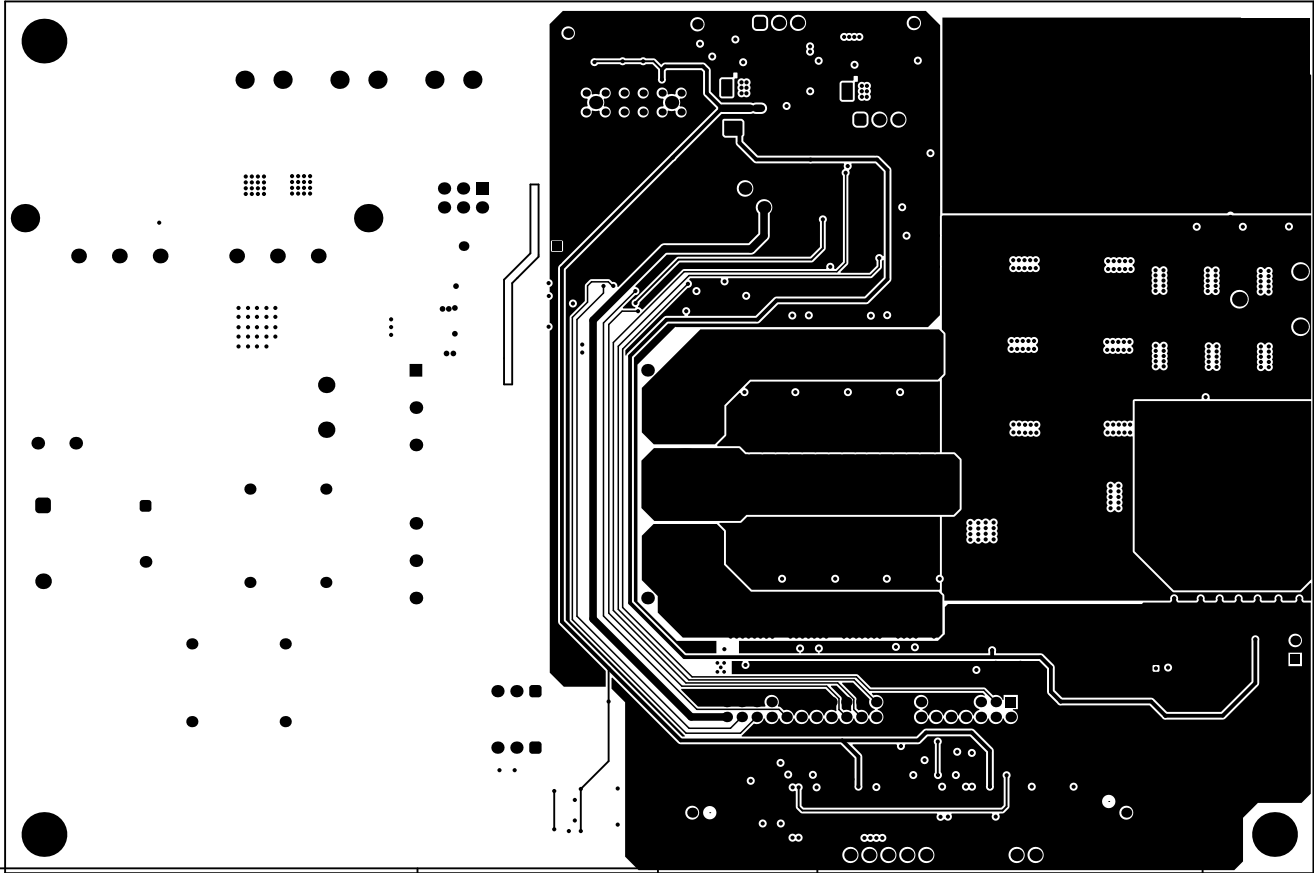
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: .TID		
PLOT NAME = Top Solder Mask	GENERATED : 9/19/2023	1:29:21 PM	TEXAS INSTRUMENTS



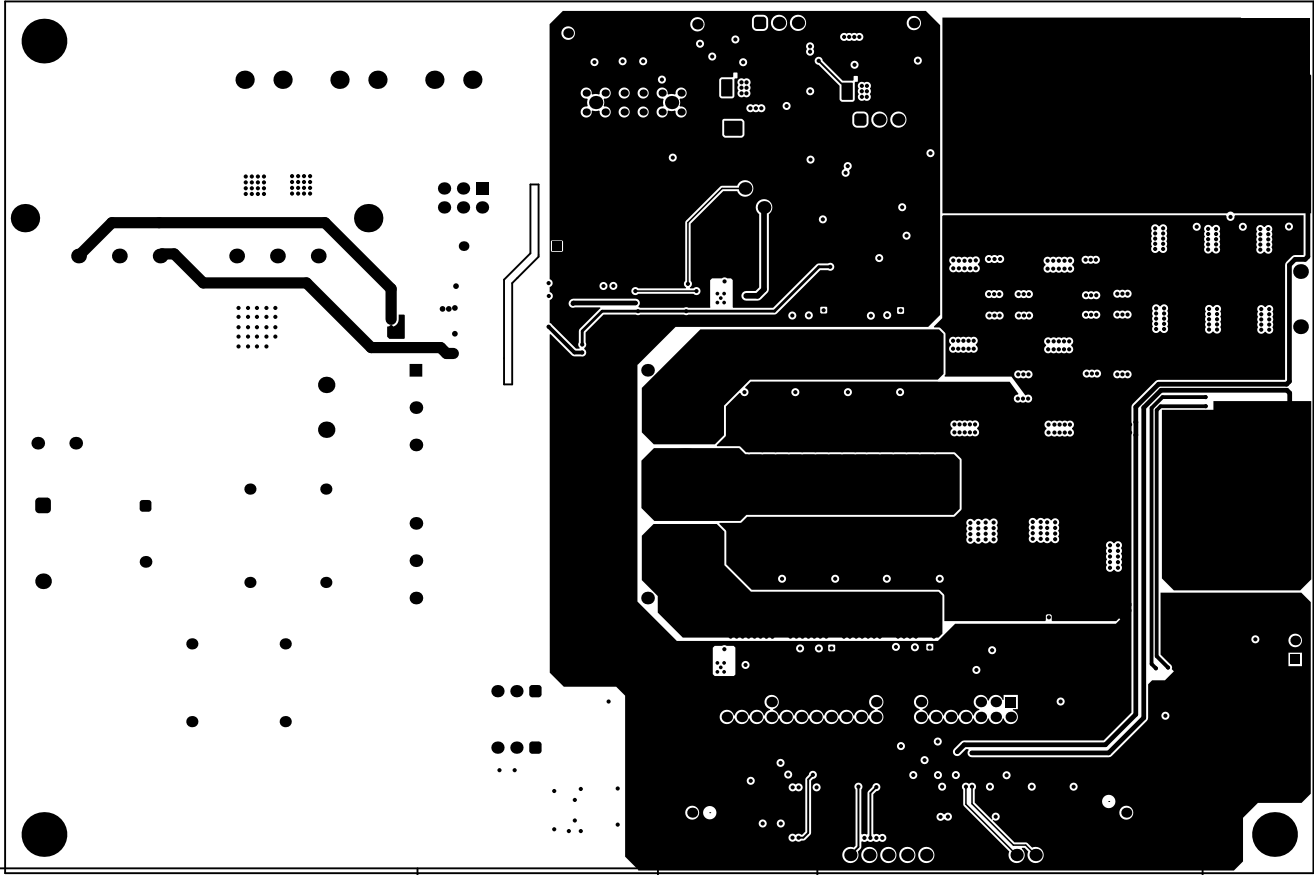
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	.PRJ_Number	REV:	.PCB_Rev	SUN REV:	Not in version control
LAYER NAME = Top Layer	TID #:	.TID				
PLOT NAME = Top Layer	GENERATED	: 9/19/2023	1:29:21 PM	TEXAS INSTRUMENTS		



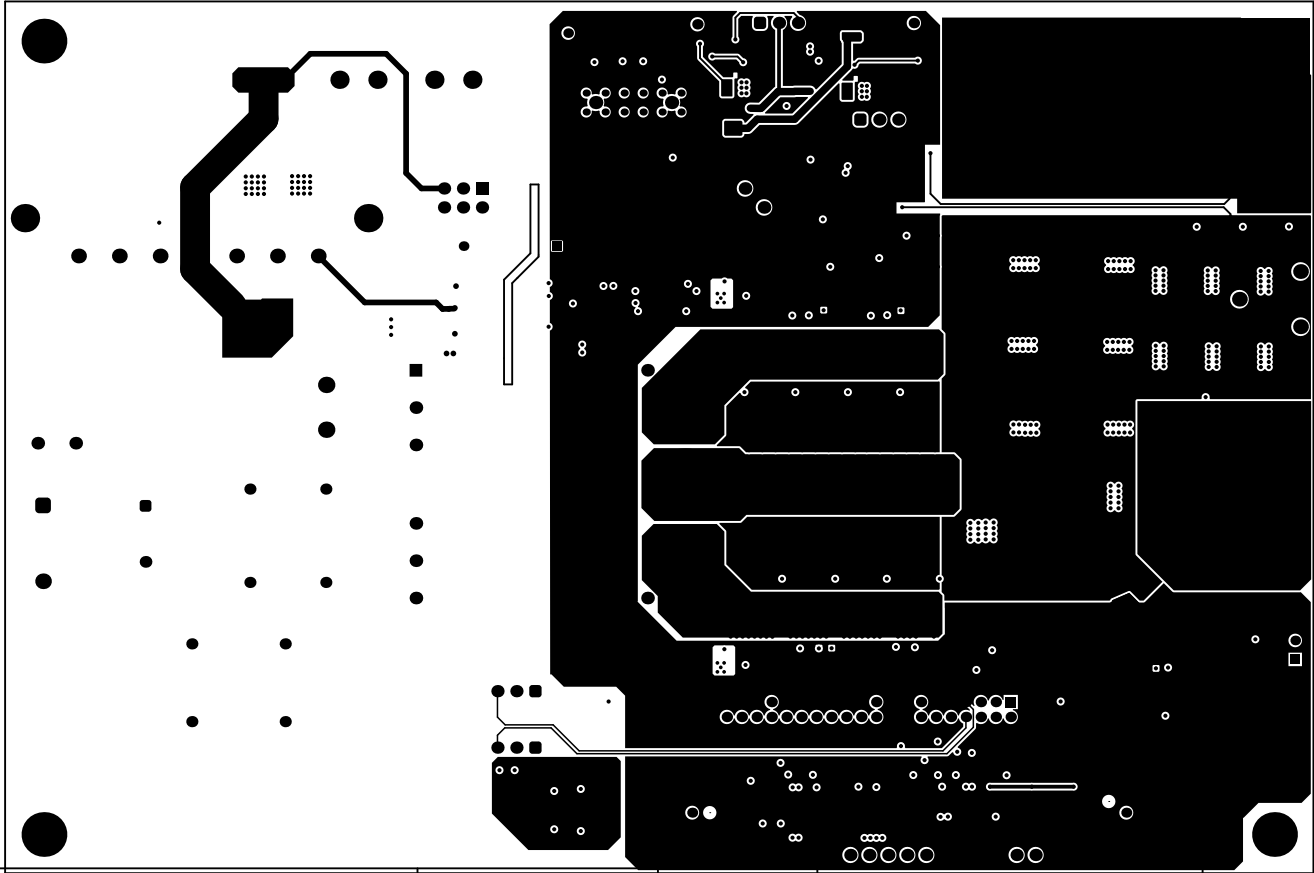
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME =	TID #: .TID		
PLOT NAME = Signal 1	GENERATED : 9/19/2023 1:29:22 PM	TEXAS INSTRUMENTS	



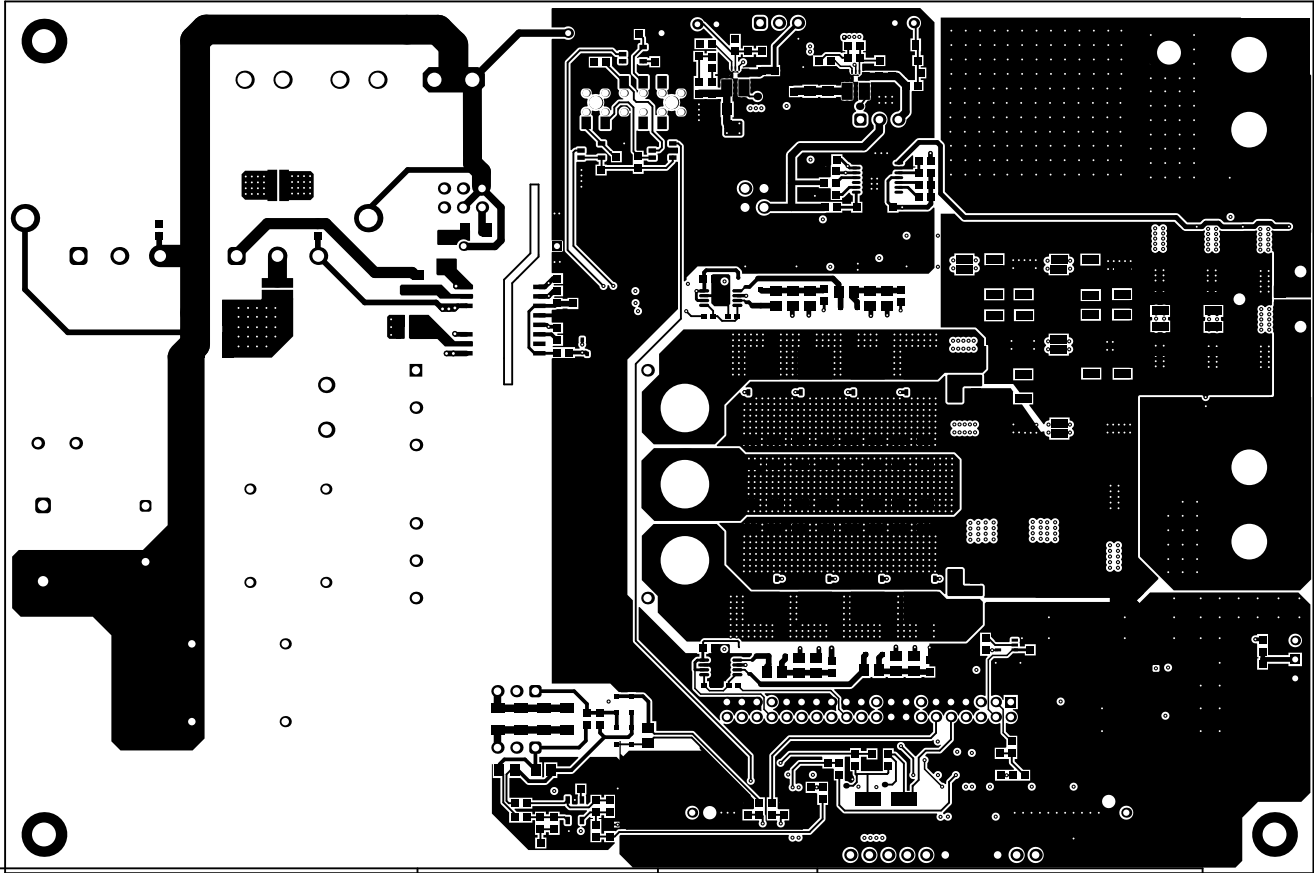
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	.PRJ_Number	REV:	.PCB_Rev	SUN REV:	Not in version control
LAYER NAME =	TID #:	.TID				
PLOT NAME =	Signal 2	GENERATED	: 9/19/2023	1:29:22 PM	TEXAS INSTRUMENTS	



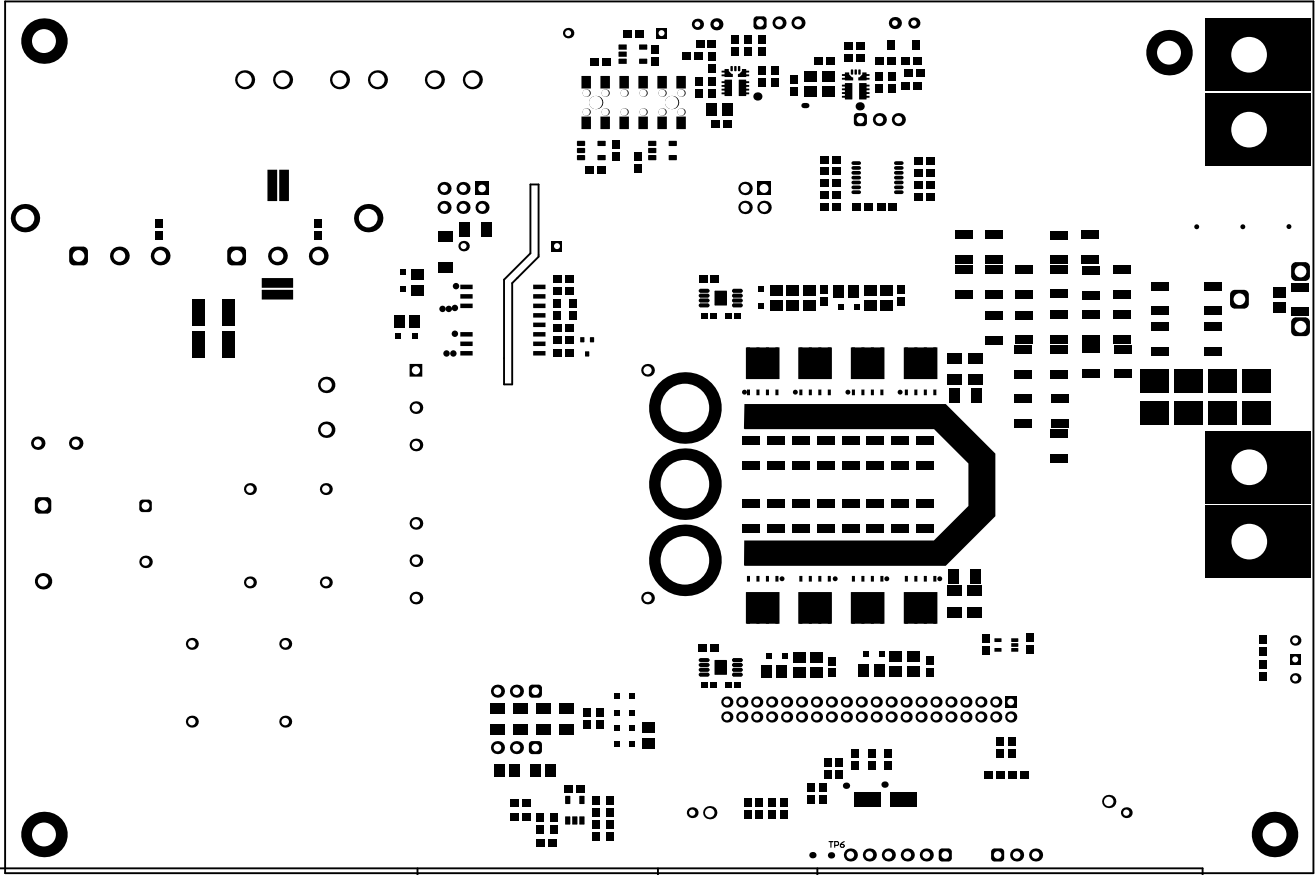
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	.PRJ_Number	REV:	.PCB_Rev	SUN REV:	Not in version control
LAYER NAME =	TID #:	.TID				
PLOT NAME =	Signal 3	GENERATED	: 9/19/2023	1:29:22 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	.PRJ_Number	REV:	.PCB_Rev	SUN REV:	Not in version control
LAYER NAME =	TID #:	.TID				
PLOT NAME =	Signal 4	GENERATED	: 9/19/2023	1:29:23 PM	TEXAS INSTRUMENTS	

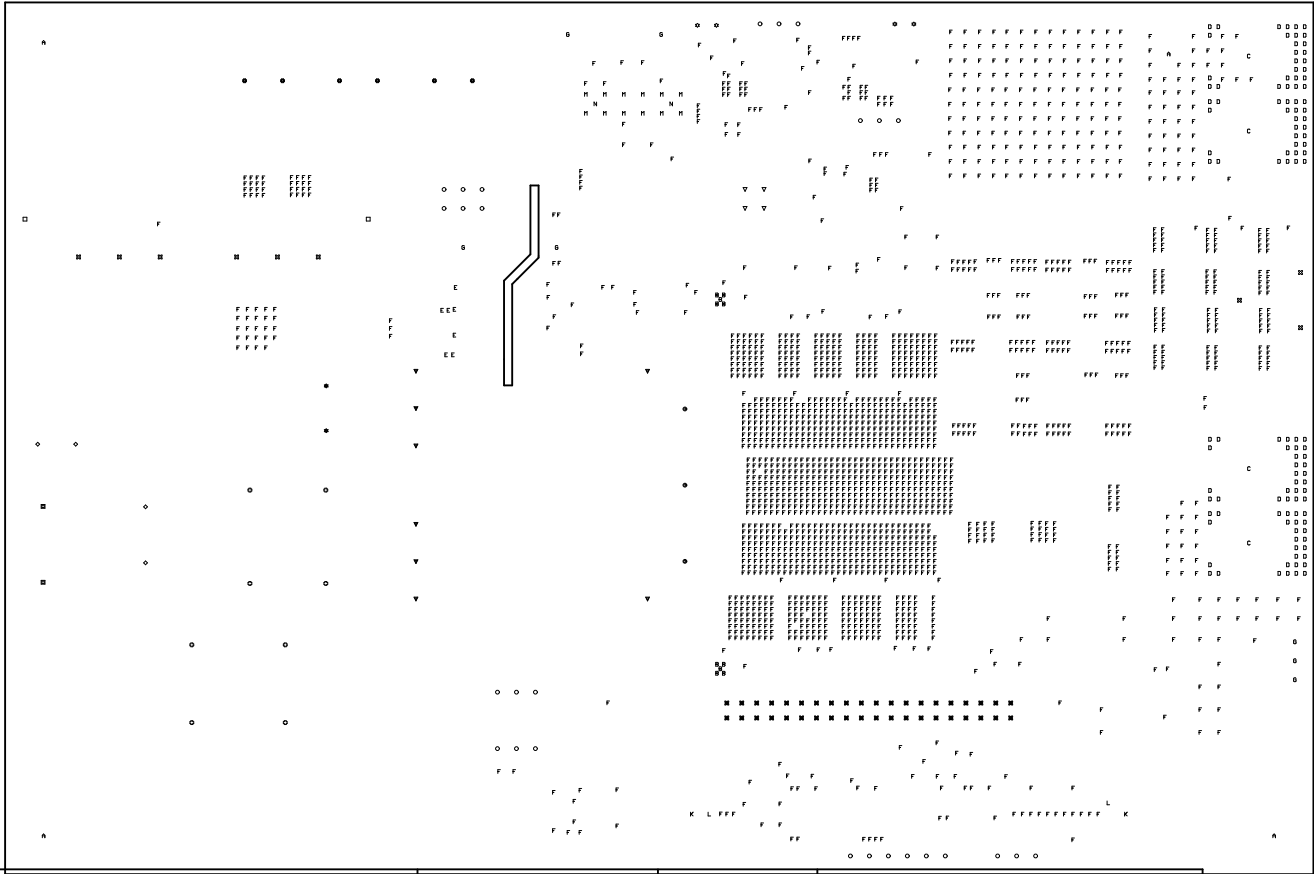


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: .TID		
PLOT NAME = Bottom Layer	GENERATED : 9/19/2023 1:29:23 PM	TEXAS INSTRUMENTS	



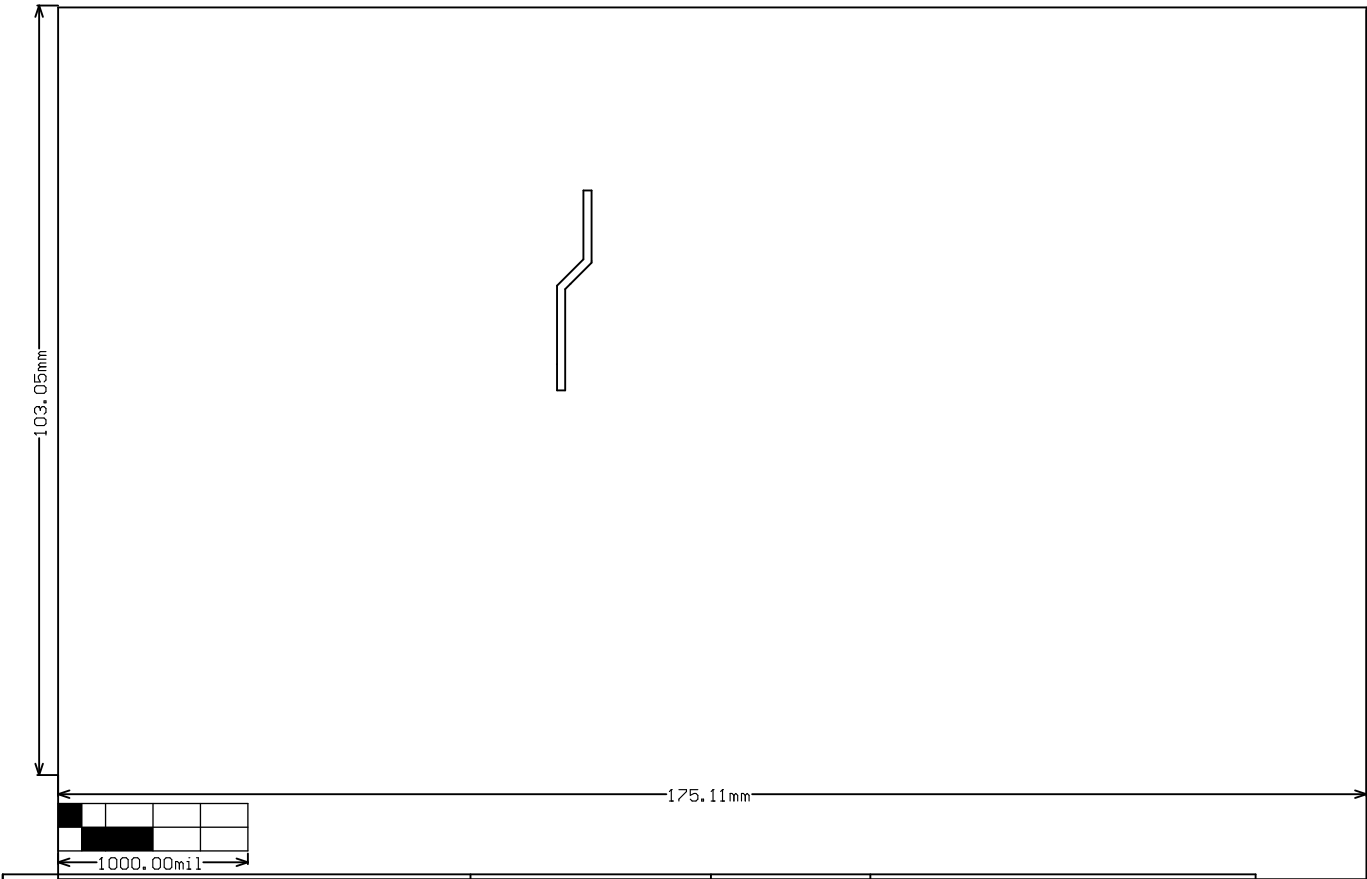
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: .TID		
PLOT NAME = Bottom Solder Mask	GENERATED : 9/19/2023 1:29:24 PM	TEXAS INSTRUMENTS	





Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
M	12	38.19mil (0.970mm)	NPTH	Round	Top Layer - Bottom Layer	+3,94mil/-0,00mil
L	2	50.00mil (1.270mm)	NPTH	Round	Top Layer - Bottom Layer	
N	2	70.08mil (1.780mm)	NPTH	Round	Top Layer - Bottom Layer	
B	10	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
F	2223	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
E	7	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
D	112	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	
☆	4	30.00mil (0.762mm)	PTH	Round	Top Layer - Bottom Layer	
G	7	31.50mil (0.800mm)	PTH	Round	Top Layer - Bottom Layer	
K	2	33.07mil (0.840mm)	PTH	Round	Top Layer - Bottom Layer	
✕	40	35.00mil (0.889mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	8	39.37mil (1.000mm)	PTH	Round	Top Layer - Bottom Layer	
○	27	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
◇	4	41.34mil (1.050mm)	PTH	Round	Top Layer - Bottom Layer	
▼	8	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
▽	4	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	
■	2	55.12mil (1.400mm)	PTH	Round	Top Layer - Bottom Layer	
✱	2	59.06mil (1.500mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	9	62.00mil (1.575mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	6	75.00mil (1.905mm)	PTH	Round	Top Layer - Bottom Layer	
□	2	98.43mil (2.500mm)	PTH	Round	Top Layer - Bottom Layer	
A	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
C	4	188.00mil (4.775mm)	PTH	Round	Top Layer - Bottom Layer	
⊙	3	255.91mil (6.500mm)	PTH	Round	Top Layer - Bottom Layer	
2504 Total						

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: .PRJ_Number	REV: .PCB_Rev	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: .TID		
PLOT NAME = Drill Drawing	GENERATED : 9/19/2023 1:29:25 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	.PRJ_Number	REV:	.PCB_Rev	SUN REV:	Not in version control
LAYER NAME = M2 Board Dimensions	TID #:	.TID				
PLOT NAME = Board Dimensions	GENERATED	: 9/19/2023	1:29:26 PM	TEXAS INSTRUMENTS		

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